NSN 5998-01-522-0259

Backplane Assembly - Page 1 of 1



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End Application:

Nsn 4940-01-471-6396, electronic shop, transportable; w/s: missile, patriot

Product Name:

Wirewrap board, assembly - mother board

Special Features:

Board: glass epoxy (multilayer) type gf per mil-p-13949; printed circuitry shall be 2 oz copper; connector and terminal holes plated through, mil-std-275; solder coat all exposed copper surfaces and plated through holes, mil-std-275, followed by reflow; apply polymer shider mask coating in selective areas to support marking requirements on component side (layer 1) and dip side (layer 4) conforming to ipc-sm-840, class 3, color green; fabricate per mil-p-55110.

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

A511k0